

ALASING
MICROSYSTEMS

HD-PRO



ULTRA COMPACT ALL-IN-ONE LASER MICROMACHINING SYSTEM



ULTRA-COMPACT,
PRODUCTION-READY
FOOTPRINT



ALL-IN-ONE MICRO-
MACHINING & 3D
METROLOGY

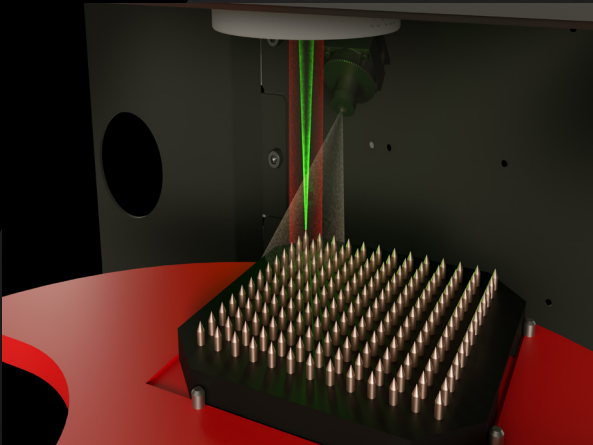


SUB-MICRON ACCURACY
& NANOMETRIC
RESOLUTION



LASER-AGNOSTIC
& FULLY AUTOMATED

WHERE FEMTOSECOND PRECISION MEETS ULTRA-COMPACT ENGINEERING



HDPRO is a high-performance, ultra-compact, all-in-one laser micromachining platform that integrates laser processing, precision motion, advanced vision, and 3D surface metrology within a single Class-1 enclosure.

Designed for both industrial production and advanced R&D environments, HDPRO supports short to ultrashort pulsed laser sources and delivers sub-micron laser processing with nanometric positioning resolution.

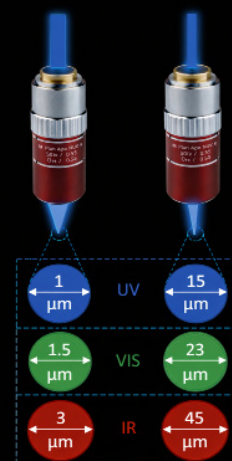
HDPRO integrates a confocal interferometer 3D profiler, enabling immediate, in-situ inspection directly inside the machine. This transforms HDPRO into a true lab-in-a-machine, where fabrication and metrology coexist in a single automated workflow.

KEY SPECIFICATIONS

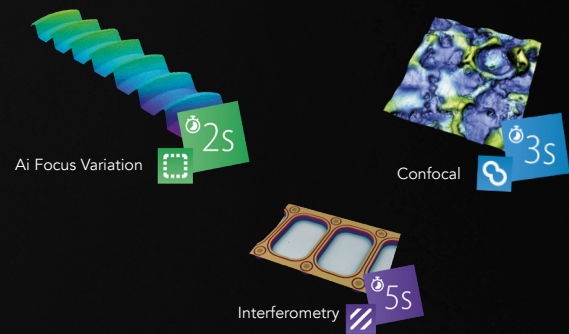


WORKING AREA	3 times 100 mm x 100 mm x 5mm
RESOLUTION	Down to 20 nm (XY), 0.1 μm (Z)
REPEATABILITY	$\pm 0.3 \mu\text{m}$ (XY); $\pm 0.1 \mu\text{m}$ (Z)
ACCURACY	$\pm 2.5 \mu\text{m}$ (XY); $\pm 1 \mu\text{m}$ (Z)
AVAILABLE LASER SOURCES	VIS-UV ns or IR-VIS fs or UV fs
SUBSTRATE HOLDER	Custom
MINIMUM LASER SPOT SIZE	Down to 2 μm
EXTERNAL DIMENSIONS	450 mm x 750 mm x 1000 mm (WxDxH)
WEIGHT	Approx. 120 kg
CONTROL UNITS	Integrated PC with dual 27" monitor

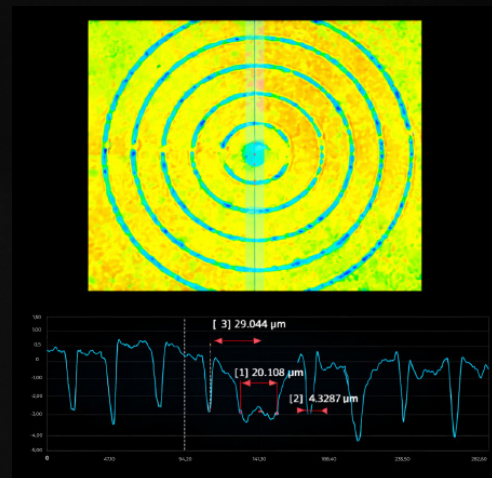
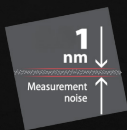
LASER OPTIONS	MAX POWER & ENERGY	PULSE WIDTH
ns-532 ns-355	1 W - 20 μJ 0.4 W - 8 μJ	< 15 ns
ns-532 HP ns-355 HP	2.5 W - 30 μJ 3 W - 30 μJ	< 15 ns
ns-532 HE ns-355 HE	1 W - 100 μJ 2 W - 100 μJ	< 15 ns
fs-1030 fs-515	10 W - 100 μJ 5 W - 50 μJ	< 400 fs
fs-343	10 W - 25 μJ	< 800 fs



HIGH RESOLUTION 3D OPTICAL PROFILER WITH TRIPLE TECHNOLOGY

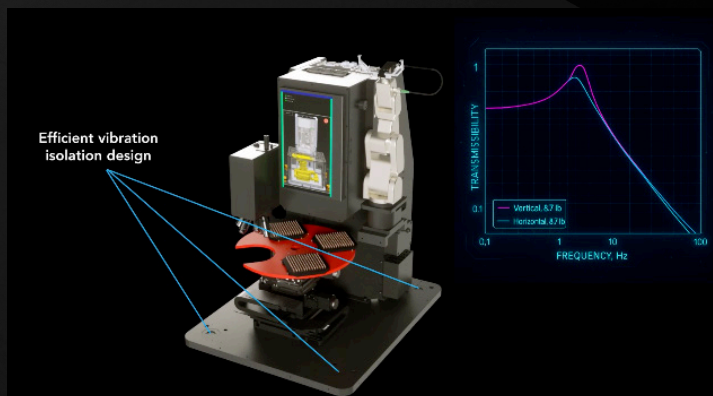
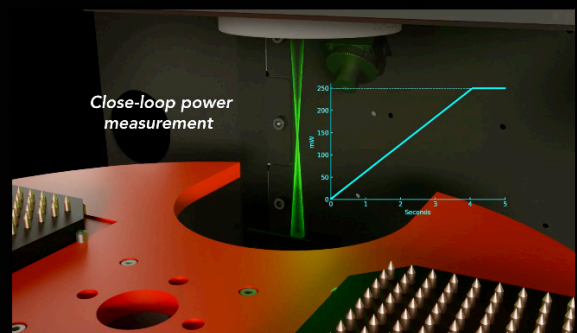


- From 5X to 100X objective magnifications.
- Motorized torret with up to 7 objectives.
- Vertical resolution down to 1 nm in DZ.
- Horizontal resolution down to 0.25 μm .
- Automatic stitching of full working area.
- Advanced and intuitive 3D measurement software.
- Automatic report generation (PDF, CSV, 3D format).



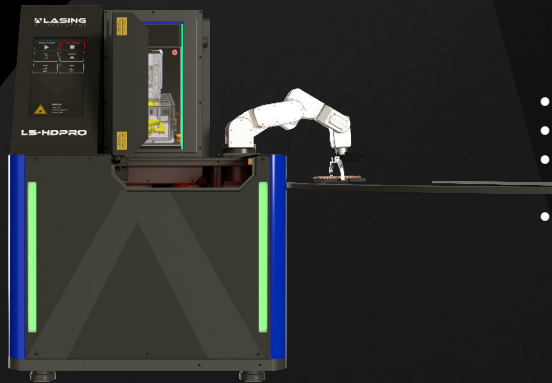
MEASURE THE MACHINE PERFORMANCE

- Closed loop power measurement on working area.
- Closed loop laser beam alignment algorithms.
- Data generation with critical variables.
- Automatic report generation (PDF, CSV, 3D format).



- Automatic lens calibration procedures.
- Co-linear laser to perform DZ and Tip-Tilt automatic adjustments.
- Isolation platform with active vibration measurement control.

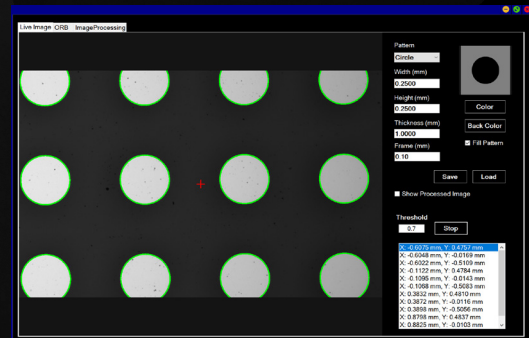
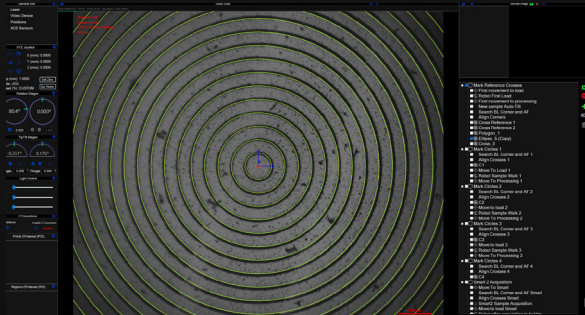
READY FOR MASS PRODUCTION



- Motorized door with program synchronism.
- 360 ° Rotation plate to holds 3 samples.
- 6 axis robot arm for up to 0.5 kg load and 50 μm repeatability.
- Digital & analog Inputs and Outputs for external synchronization.



POWERFUL SOFTWARE LPS



- Intuitive clean codeless software.
- Design and import CAD trajectories (dxf, dwg, Gcode).
- Import image files.
- Control of full laser parameters.
- Vision plugins for automatic recognition.
- 3D profiler functionalities integrated.
- 3D closed loop correction to minimize stitching errors.
- Automatic report generation.



Camera Stitch



Autofocus



Galvo distortion connection



Galvo calibration



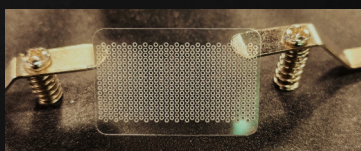
Visual inspection



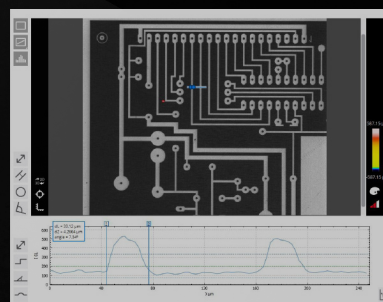
Track view

APPLICATIONS

- Microelectronics & Semiconductor R&D.
- Photonics & Optoelectronics.
- Microfluidics & Biomedical Devices.
- Advanced Materials & Functional Surfaces.
- General Surface structuring.

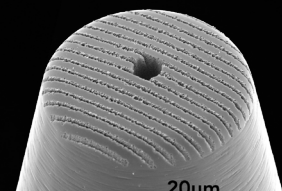


Fused silica micro-drilling



OCT Thin-film nano-patterning

Alumina tips micro-texturing



LASER & OPTICS

COMPATIBLE LASER SOURCES	Nanosecond, femtosecond
SUPPORTED WAVELENGTHS	IR, Green, UV (laser-dependent)
LASER INTEGRATION	Internal or external customer-supplied laser
MINIMUM LASER SPOT SIZE	Down to 2 μm
BEAM DELIVERY	Galvo-scanner + motorized XYZ stages
FOCUSING OPTICS	From 60 mm FL and up to 40 $\times$ high-NA objective
OPTICAL CONFIGURATIONS	Galvo+objective; galvo + f-theta, axicons
POLARIZATION CONTROL	Manual or automated (linear, circular, elliptical)
POWER MONITORING	Integrated power meter

MOTION & POSITIONING

MOTION AXES	Up to 6 axes (XYZ + rotation / tilt, configurable)
WORKING VOLUME	3 x (100 mm x 100 mm x 5 mm)
POSITIONING RESOLUTION (XY/Z)	XY: 20 nm resolution / 300 nm repeatability / < 2.5 μm accuracy Z: 100 nm resolution / 100 nm repeatability / < 1 μm accuracy

VISION & METROLOGY

VISION SYSTEM	Co-axial & Parallel Dual high resolution vision systems
VISION FUNCTIONS	Automated field calibration and features recognition
INTEGRATED PROFILER	Confocal interferometer 3D profiler
PROFILER RESOLUTION	Vertical down to 1 nm, lateral down to 200 nm
MEASUREMENT OUTPUT	True 3D surface topography
INSPECTION	Automated pass/fail inspection & process feedback

SAMPLE HOLDING

SAMPLE HOLDER	Custom substrate holders for each application
SAMPLE ALIGNMENT	Automated alignment & rotation compensation
SAMPLE TRANSFER	Automated transfer between processing & metrology
MULTI-POSITION FIXTURES	True 3D surface topography

SOFTWARE & AUTOMATION

CONTROL SOFTWARE	Proprietary all-in-one control environment
SOFTWARE FUNCTIONS	Laser parameters, motion control, optics & metrology
WORKFLOW	Fabricate --> Measure --> Optimize
CAD SUPPORT	DXF, DWG and standard CAD formats